2SD0968A (2SD968A)

Silicon NPN epitaxial planar type

For low-frequency driver amplification Complementary to 2SB0789A (2SB789A)

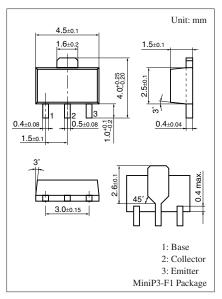
Features

- High collector-emitter voltage (Base open) V_{CEO}
- Large collector power dissipation P_C
- Mini power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

\blacksquare Absolute Maximum Ratings $T_a = 25 ^{\circ} C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V_{CBO}	120	V	
Collector-emitter voltage (Base open)	V _{CEO}	120	V	
Emitter-base voltage (Collector open)	V_{EBO}	5	V	
Peak collector current	I_{CP}	1	A	
Collector current	I_C	0.5	A	
Collector power dissipation *	P _C	1	W	
Junction temperature	T_{j}	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

Note) *: Print circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion.



Marking Symbol: V

■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 100 \ \mu A, I_B = 0$	120			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_E = 10 \ \mu A, I_C = 0$	5			V
Forward current transfer ratio *1	h _{FE1} *2	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	130		330	
	h _{FE2}	$V_{CE} = 5 \text{ V}, I_{C} = 500 \text{ mA}$	50			
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.2	0.6	V
Base-emitter saturation voltage *1	V _{BE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.85	1.20	V
Transition frequency	f_T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	Cob	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$			20	pF
(Common base, input open circuited)						

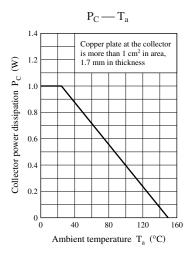
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

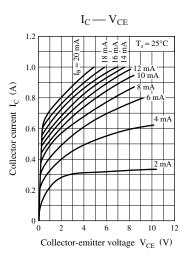
2. *1: Pulse measurement

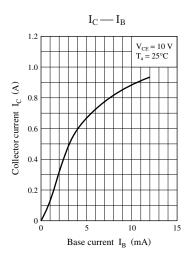
*2: Rank classification

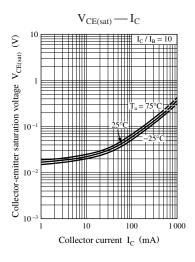
Rank	R	S
$h_{\mathrm{FE}1}$	130 to 220	185 to 330

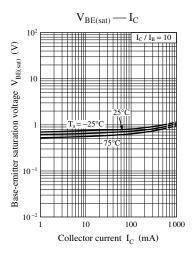
Note) The part numbers in the parenthesis show conventional part number.

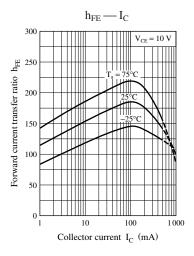


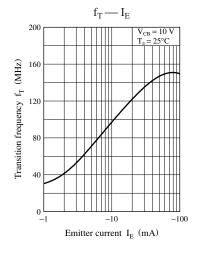


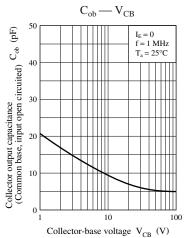












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